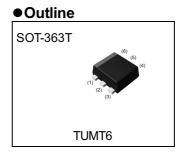
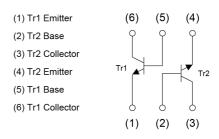


**Complex Midium Power Transistor** 

Parameter	Tr1 and Tr2
V <sub>CEO</sub>	12V
Ι <sub>C</sub>	1.5A



## Inner circuit



## •Features 1)High current

2)Low saturation voltage

V<sub>CE(sat)</sub>: max.200mV

at I<sub>C</sub>=500mA/I<sub>B</sub>=25mA

## Application

LOW FREQUENCY AMPLIFIER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
US6X7	SOT-363T (TUMT6)	2021	TR	180	8	3000	X07

Parameter	Symbol	Values	Unit
Collector-base voltage	V <sub>CBO</sub>	15	V
Collector-emitter voltage	V <sub>CEO</sub>	12	V
Emitter-base voltage	V <sub>EBO</sub>	6	V
	Ι <sub>C</sub>	1.5	А
Collector current	I <sub>CP</sub> *1	3	А
Deuren die ein etien	P <sub>D</sub> *2	0.4	W/Total
Power dissipation	P <sub>D</sub> *3*4	1.0	W/Total
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ ) <It is the same ratings for the Tr1 and Tr2>

## •Electrical characteristics (T<sub>a</sub> = 25°C) <It is the same characteristics for the Tr1 and Tr2>

Deremeter	Sumbol	Conditions	Values			Linit	
Parameter	Symbol	Conditions	Min. Typ.		Max.	- Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	Ι <sub>C</sub> = 10μΑ	15	-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	12	-	-	V	
Emitter-base breakdown voltage	BV <sub>EBO</sub>	Ι <sub>Ε</sub> = 10μΑ	6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 15V	-	-	100	nA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 6V	-	-	100	nA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 500mA, I <sub>B</sub> = 25mA	-	85	200	mV	
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 2V, I <sub>C</sub> = 200mA	270	-	680	-	
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = 2V, I <sub>E</sub> = -200mA, f = 100MHz	-	400	-	MHz	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A, f = 1MHz	-	12	-	pF	

\*1 Pw=1ms Single pulse

\*2 Each terminal mounted on a reference land.

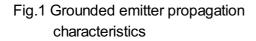
\*3 Mounted on a ceramic board.(25×25×0.8mm)

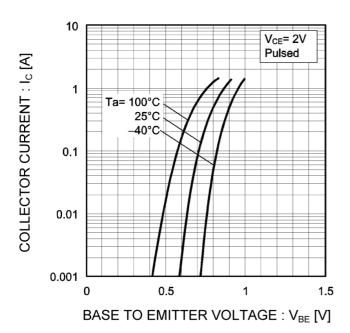
\*4 0.7W per element must not be exceeded.

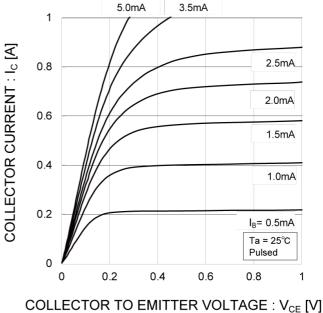


## • Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>



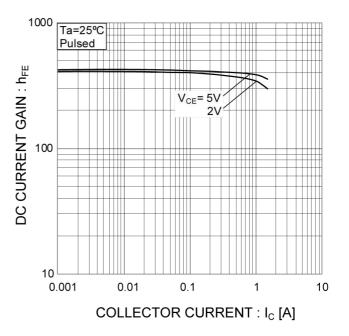




### Fig.2 Typical output characteristics

Fig.3 DC current gain vs. collector current (I)

1000  $Ta = 100^{\circ}C$ 100 100 100 100 100 100 100 0.01 0.1 1 100 COLLECTOR CURRENT : I<sub>c</sub> [A] Fig.4 DC current gain vs. collector current (II)



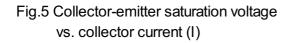
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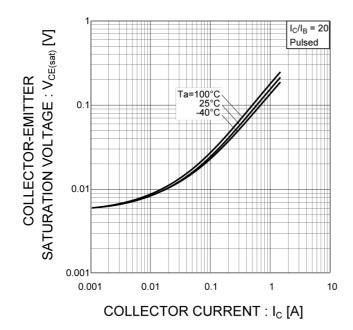
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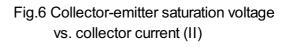
## •Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>





# Fig.7 Base-emitter saturation voltage vs. collector current



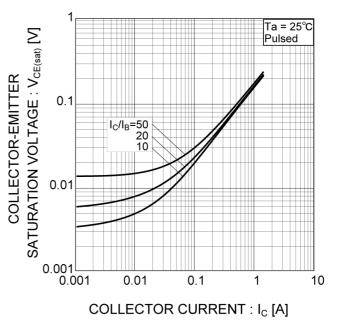
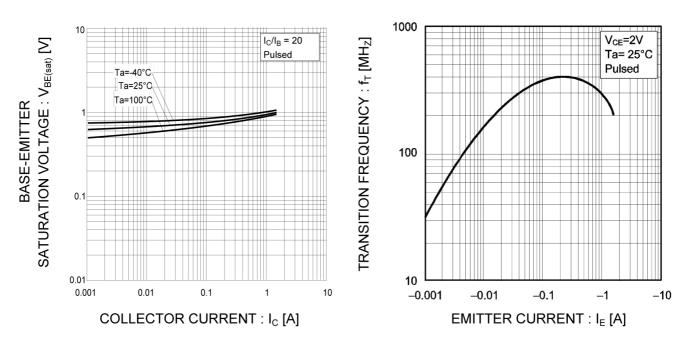


Fig.8 Gain bandwidth product vs. emitter current



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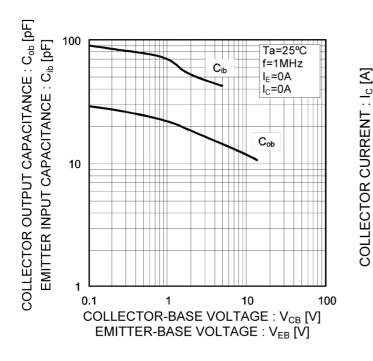
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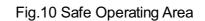


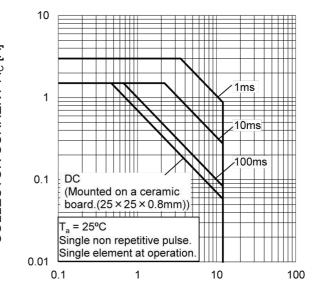
## • Electrical characteristic curves ( $T_a = 25^{\circ}C$ )

<For Tr1 and Tr2 in common>

Fig.9 Collector output capacitance vs. collector-base voltage Emitter input capacitance vs. emitter-base voltage





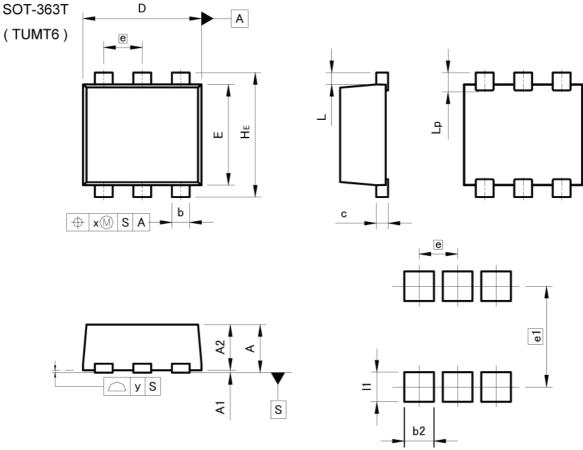


COLLECTOR TO EMITTER VOLTAGE :  $V_{\text{CE}}\left[V\right]$ 





## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
A	<u></u> 2	0.85	-	0.033	
A1	0.00	0.05	0.000	0.002	
A2	0.72	0.82	0.028	0.032	
b	0.25	0.40	0.010	0.016	
с	0.12	0.22	0.005	0.009	
D	1.90	2.10	0.075	0.083	
E	1.60	1.80	0.063	0.071	
е	0.65		0.026		
HE	2.00	2.20	0.079	0.087	
L	0.20		0.008		
Lp	<u>12</u> 7	0.40	-	0.016	
x	<u>1</u> 28	0.10	12 12	0.004	
у	<b>1</b>	0.10	5	0.004	
	MILIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
b2	-	0.50	-	0.020	
e1	1.	70	0.0	067	
11	<u>84</u> 5	0.50	-	0.020	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of	the Specific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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